

# LINEAR SYSTEMS

Twenty-Five Years Of Quality Through Innovation

## LS627

PHOTO FET  
LIGHT SENSITIVE JFET

### FEATURES

DIRECT REPLACEMENT FOR CRYSTALONICS FF627  
FLAT GLASS TOP FOR EXTERNAL OPTICS  
ULTRA HIGH SENSITIVITY

### ABSOLUTE MAXIMUM RATINGS<sup>1</sup> @ 25 °C (unless otherwise stated)

#### Maximum Temperatures

Storage Temperature	-65 to +200 °C
Operating Junction Temperature	-55 to +165 °C

#### Maximum Power Dissipation

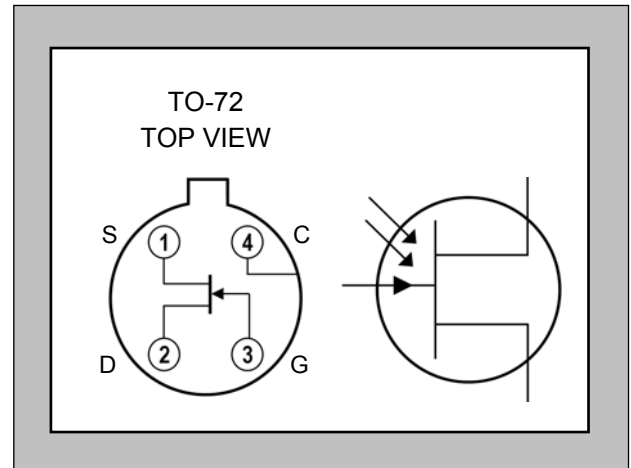
Continuous Power Dissipation, T <sub>A</sub> =25°C	400mW
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#### Maximum Currents

Drain to Source	50mA
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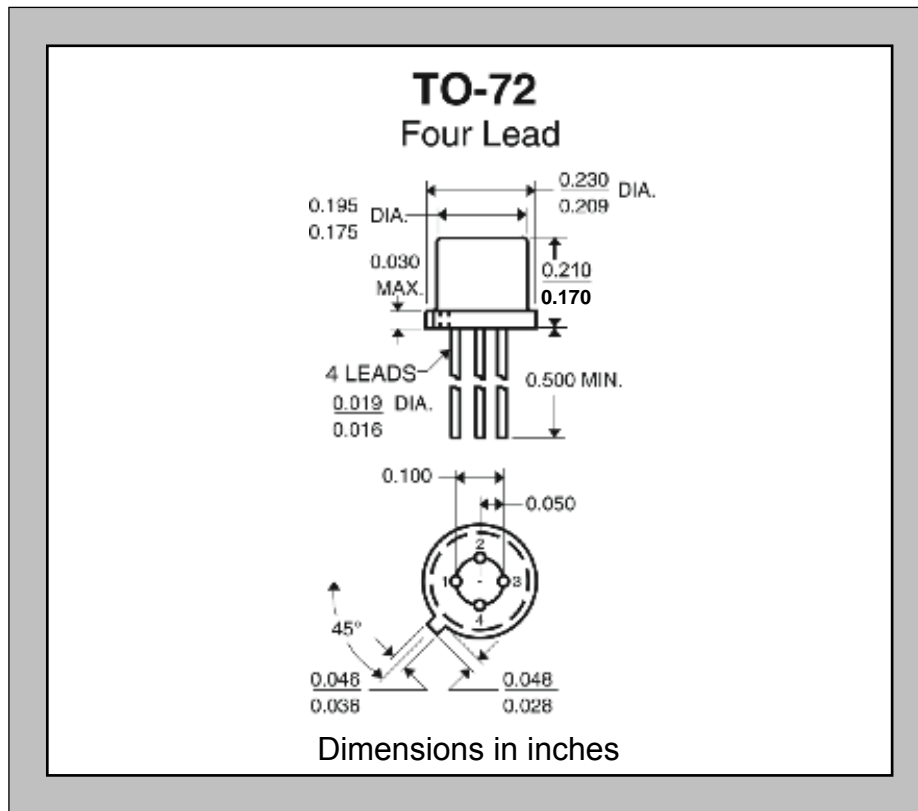
#### Maximum Voltages

Drain to Gate	15V
Drain to Source	15V
Gate to Source	-10V



### ELECTRICAL CHARACTERISTICS @ 25 °C (unless otherwise stated)

SYMBOL	CHARACTERISTIC	MIN	TYP	MAX	UNITS	CONDITIONS
V <sub>GS(off)</sub>	Gate to Source cutoff Voltage (V <sub>PO</sub> )	1.0		5.0	V	V <sub>DS</sub> = 10V, I <sub>D</sub> = 0.1μA
S <sub>G</sub>	Gate Sensitivity <sup>2,7</sup>	6.4		24	μA/mW/cm <sup>2</sup>	V <sub>DS</sub> = 10V, V <sub>GS</sub> = 0V, λ = 0.9μm
S <sub>D</sub>	Drain Sensitivity <sup>3,7</sup>		500		mA/mW/cm <sup>2</sup>	V <sub>DS</sub> = 10V, V <sub>GS</sub> = 0V, R <sub>G</sub> = 1MΩ
λ <sub>ig</sub>	Gate Current (Light) <sup>4,7</sup>	10		37.5	nA/FC	V <sub>DS</sub> = 10V, V <sub>GS</sub> = 0V
λ <sub>id</sub>	Drain Current (Light) <sup>4,7</sup>		800		μA/FC	V <sub>DS</sub> = 10V, V <sub>GS</sub> = 0V, R <sub>G</sub> = 1MΩ
I <sub>DSS</sub>	Drain Saturation Current	8.0			mA	V <sub>DS</sub> = 10V, V <sub>GS</sub> = 0V
I <sub>GSS</sub>	Gate Leakage Current (Dark)			30	pA	V <sub>GS</sub> = -10V, V <sub>DS</sub> = 0V
g <sub>fs</sub>	Forward Transconductance (g <sub>m</sub> )	8000			μS	V <sub>DS</sub> = 10V, V <sub>GS</sub> = 0V, f = 1kHz
R <sub>DS(on)</sub>	Drain to Source On Resistance		100		Ω	V <sub>DS</sub> = 0.1V, V <sub>GS</sub> = 0V
C <sub>GS</sub>	Gate to Source Capacitance <sup>7</sup>			35	pF	V <sub>GS</sub> = -10V, f = 140kHz
C <sub>GD</sub>	Gate to Drain Capacitance <sup>7</sup>			20		V <sub>GD</sub> = -10V, f = 140kHz
t <sub>r</sub>	Rise Time <sup>5,7</sup>		30		ns	V <sub>DS</sub> = 10V, R <sub>L</sub> = R <sub>G</sub> = 100Ω
t <sub>f</sub>	Fall Time <sup>6,7</sup>		50			



#### NOTES

1. Absolute maximum ratings are limiting values above which serviceability may be impaired.
2. Gate Current per unit Radiant Power Density at Lens Surface
3. Drain Current per unit Radiant Power Density ( $\lambda = 0.9\mu\text{m}$ ).
4. Tungsten Lamp 2800°K Color Temperature.
5. GaAs Diode Source.
6. Directly Proportional to  $R_G$ .
7. Not production tested. Guaranteed by design.

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Linear Integrated Systems (LIS) is a 25-year-old, third-generation precision semiconductor company providing high-quality discrete components. Expertise brought to LIS is based on processes and products developed at Amelco, Union Carbide, Intersil and Micro Power Systems by company President John H. Hall. Hall, a protégé of Silicon Valley legend Dr. Jean Hoerni, was the director of IC Development at Union Carbide, co-founder and vice president of R&D at Intersil, and founder/president of Micro Power Systems.